

# 1A, 30V - 60V Schottky Barrier Surface Mount Rectifier

#### **FEATURES**

- Very low profile typical height of 0.68mm
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converter

### **MECHANICAL DATA**

- Case: Micro SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.006g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	1	Α	
$V_{RRM}$	30 - 60	V	
I <sub>FSM</sub>	25	Α	
$T_{JMAX}$	150	°C	
Package	Micro SMA		
Configuration	Single die		







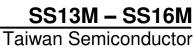


Micro SMA



PARAMETER	SYMBOL	SS13M	SS14M	SS16M	UNIT
Marking code on the device		А	В	С	
Repetitive peak reverse voltage	$V_{RRM}$	30	40	60	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	21	28	42	V
Forward current	I <sub>F</sub>	1		Α	
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	25		Α	
Junction temperature	T <sub>J</sub>	-55 to +150		°C	
Storage temperature	T <sub>STG</sub>	-55 to +150		°C	

1





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	R <sub>eJL</sub>	30	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	125	°C/W	
Junction-to-case thermal resistance	R <sub>eJC</sub>	40	°C/W	

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
		$I_F = 0.5A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.45	-	V
	SS13M	$I_F = 1.0A, T_J = 25^{\circ}C$		0.52	0.55	V
	SS14M	$I_F = 0.5A, T_J = 125$ °C		0.35	-	٧
Forward valtage (1)		$I_F = 1.0A, T_J = 125$ °C		0.46	0.50	V
Forward voltage <sup>(1)</sup>		$I_F = 0.5A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.51	-	V
	001014	$I_F = 1.0A, T_J = 25$ °C		0.64	0.68	٧
	SS16M	$I_F = 0.5A, T_J = 125$ °C		0.46	-	V
		$I_F = 1.0A, T_J = 125$ °C		0.57	0.60	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>		$T_J = 25^{\circ}C$	I <sub>R</sub>	-	50	μΑ
		T <sub>J</sub> = 125°C		-	10	mA
Junction capacitance	SS13M SS14M	1MHz, V <sub>R</sub> = 4.0V	CJ	50	-	pF
•	SS16M			40	-	pF

## Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
SS1xM	Micro SMA	12,000 / Tape & Reel		

## Notes:

1. "x" defines voltage from 30V(SS13M) to 60V(SS16M)



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

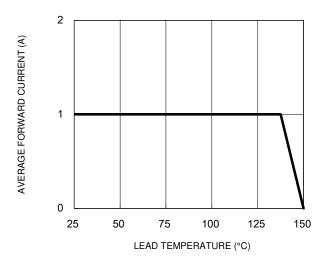


Fig.3 Typical Reverse Characteristics

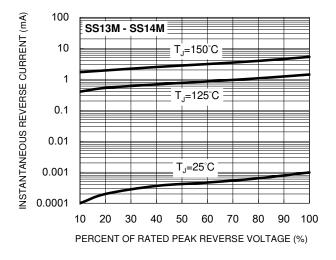


Fig.5 Typical Reverse Characteristics

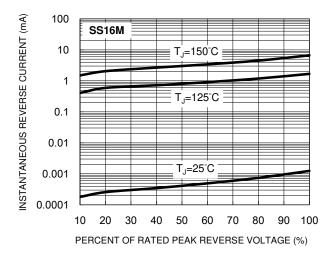


Fig.2 Typical Junction Capacitance

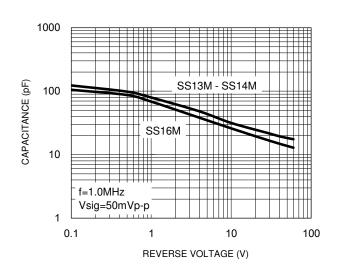


Fig.4 Typical Forward Characteristics

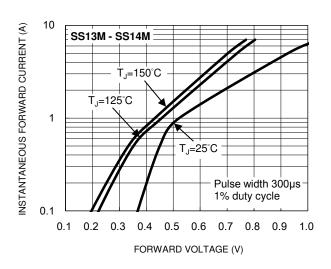
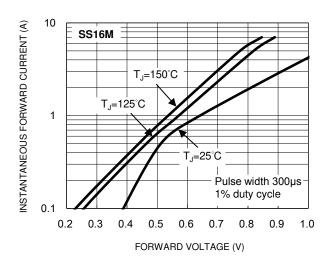


Fig.6 Typical Forward Characteristics





## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.7 Maximum Non-Repetitive Forward Surge Current

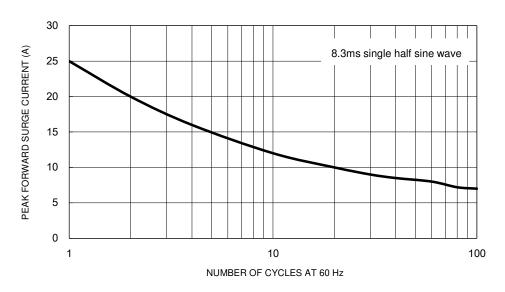
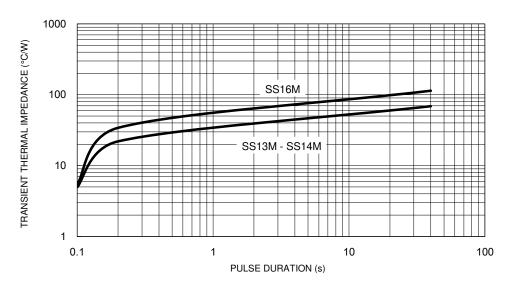


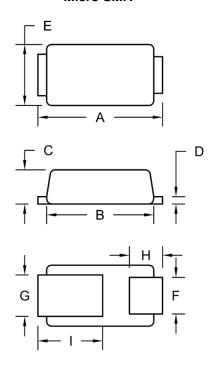
Fig.8 Typical Transient Thermal Impedance





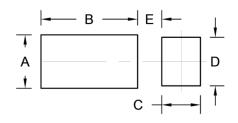
# **PACKAGE OUTLINE DIMENSIONS**

# Micro SMA



DIM.	Unit (mm)		Unit (	(inch)
Dilvi.	Min.	Max.	Min.	Max.
Α	2.30	2.70	0.091	0.106
В	2.10	2.30	0.083	0.091
С	0.63	0.73	0.025	0.029
D	0.10	0.20	0.004	0.008
E	1.15	1.35	0.045	0.053
F	0.65	0.85	0.026	0.034
G	0.75	0.95	0.030	0.037
Н	0.55	0.75	0.022	0.030
I	1.10	1.50	0.043	0.059

# **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	1.10	0.043
В	2.00	0.079
С	0.80	0.031
D	1.00	0.039
E	0.50	0.020

# **MARKING DIAGRAM**



P/N = Marking Code YW = Data Code



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